

Description

The AO4818 uses advanced trench technology

to provide excellent R_{DS(ON)}, low gate charge and

operation with gate voltages as low as 2.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

D2 D1 D1 S2 G2 S2 S1

> SOP-8 (SOIC-8)

General Features

 $V_{DS} = 30V I_{D} = 8.5 A$

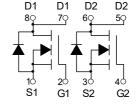
 $R_{DS(ON)} < 18m\Omega$ @ $V_{GS}=4.5V$

Application

Battery protection

Load switch

Uninterruptible power supply



Dual N-Channel MOSFET

Package Marking and Ordering Information

| Product ID | Pack | Brand | Qty(PCS) |
|------------|---------------|------------|----------|
| AO4818 | SOP-8(SOIC-8) | HXY MOSFET | 3000 |

Absolute Maximum Ratings@T_i=25°C(unless otherwise specified)

| Symbol | Parameter | Rating | Units |
|--------------------------------------|---|-------------|-------|
| V _{DS} | Drain-Source Voltage | 30 | V |
| V _G s | Gate-Source Voltage | <u>+</u> 20 | V |
| I _D @T _A =25°C | Drain Current, V _{GS} @ 4.5V ³ | 8.5 | А |
| I _D @T _A =70°C | Drain Current, V _{GS} @ 4.5V ³ | 5.8 | А |
| Ірм | Pulsed Drain Current ¹ | 37 | А |
| P _D @T _A =25°C | Total Power Dissipation | 1.5 | W |
| Тѕтс | Storage Temperature Range | -55 to 150 | °C |
| TJ | Operating Junction Temperature Range | -55 to 150 | °C |
| Rthj-a | Maximum Thermal Resistance, Junction- ambient ³ | 85 | °C/W |

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit | |
|--------------------------------------|--|---|------|-------|------|-------|--|
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V , I _D =250uA | 30 | | | V | |
| $\triangle BV_{DSS}/\triangle T_{J}$ | BVDSS Temperature Coefficient | Reference to 25°C , I _D =1mA | | 0.034 | | V/°C | |
| | Static Drain-Source On-Resistance ² | V_{GS} =10V , I_D =7A | - | 15 | 18 | mΩ | |
| R _{DS(ON)} | Static Dialii-Source On-Resistance | V _{GS} =4.5V , I _D =4A | | 22 28 | | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | \\ -\\ -250\ | 1.2 | | 2.5 | V | |
| $\triangle V_{GS(th)}$ | V _{GS(th)} Temperature Coefficient | $V_{GS}=V_{DS}$, $I_D=250uA$ | | -5.8 | | mV/°C | |
| 1 | Drain-Source Leakage Current | V _{DS} =24V , V _{GS} =0V , T _J =25°C | | | 1 | - uA | |
| I _{DSS} | | V _{DS} =24V , V _{GS} =0V , T _J =55°C | | | 5 | | |
| I _{GSS} | Gate-Source Leakage Current | $V_{GS}=\pm 20V$, $V_{DS}=0V$ | | | ±100 | nA | |
| gfs | Forward Transconductance | V _{DS} =5V , I _D =7A | | 6 | | S | |
| R _g | Gate Resistance | V _{DS} =0V , V _{GS} =0V , f=1MHz | | 2.5 | | Ω | |
| Qg | Total Gate Charge (4.5V) | | | 6 | | | |
| Q _{gs} | Gate-Source Charge | V _{DS} =15V , V _{GS} =4.5V , I _D =7A | | 2.5 | | nC | |
| Q_{gd} | Gate-Drain Charge | | | 2.1 | | | |
| T _{d(on)} | Turn-On Delay Time | | | 2.4 | | | |
| T _r | Rise Time | V_{DD} =15V , V_{GS} =10V , R_{G} =3.3 Ω | | 7.8 | | ns | |
| T _{d(off)} | Turn-Off Delay Time | I _D =7A | | 22 | | | |
| T _f | Fall Time | | | 4 | | | |
| C _{iss} | Input Capacitance | | | 572 | | | |
| Coss | Output Capacitance | V _{DS} =15V , V _{GS} =0V , f=1MHz | | 80 | | pF | |
| C _{rss} | Reverse Transfer Capacitance | | | 65 | | | |
| Is | Continuous Source Current ^{1,5} | V V 3V 5 | | | 7.3 | Α | |
| I _{SM} | Pulsed Source Current ^{2,5} | V _G =V _D =0V , Force Current | | | 37 | Α | |
| V _{SD} | Diode Forward Voltage ² | V _{GS} =0V , I _S =1A , T _J =25°C | | | 1.2 | V | |
| t _{rr} | Reverse Recovery Time | | | 20 | | nS | |
| Q _{rr} | Reverse Recovery Charge | IF=7A , dI/dt=100A/µs , T _J =25°C | | 1.1 | | nC | |

Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leq 300 \text{us}$, duty cycle $\leq 2\%$
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V,L=0.1mH, I_{AS} =21A
- 4. The power dissipation is limited by 150°C junction temperature
- 5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

Typical Characteristics

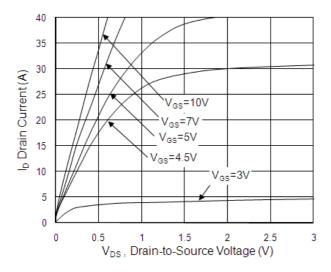


Fig.1 Typical Output Characteristics

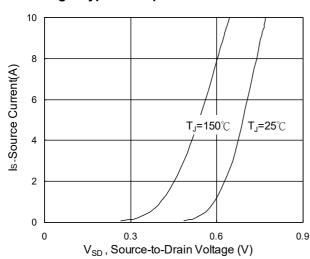


Fig.3 Forward Characteristics Of Reverse

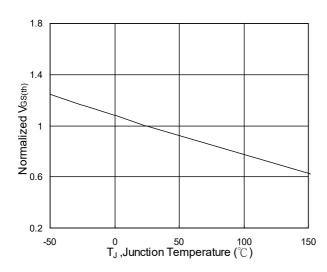


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

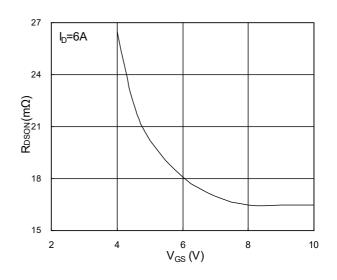


Fig.2 On-Resistance vs. G-S Voltage

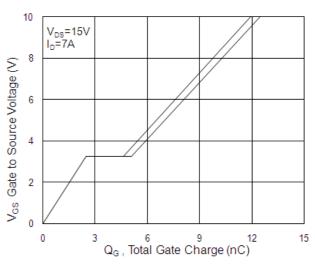


Fig.4 Gate-Charge Characteristics

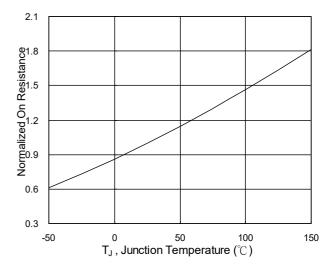
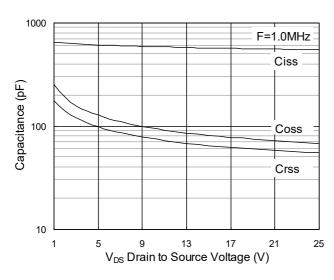


Fig.6 Normalized R_{DSON} vs. T_J



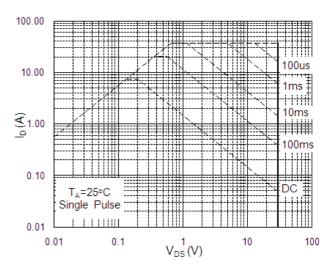


Fig.7 Capacitance

Fig.8 Safe Operating Area

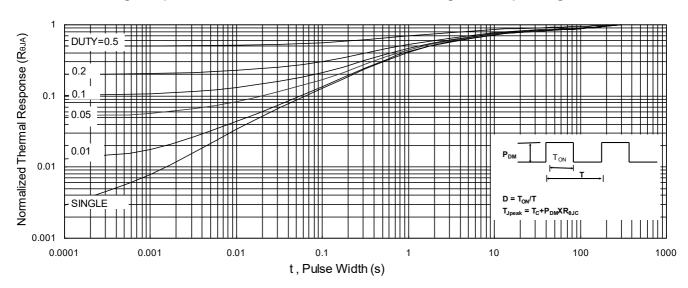


Fig.9 Normalized Maximum Transient Thermal Impedance

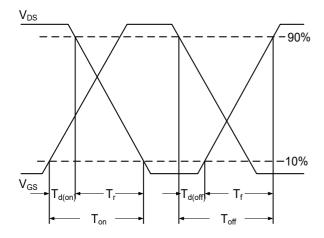


Fig.10 Switching Time Waveform

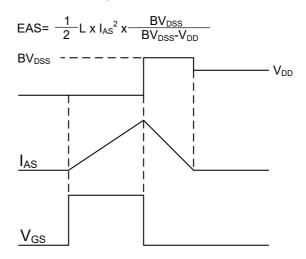
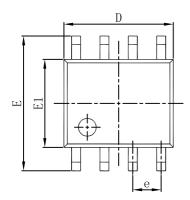
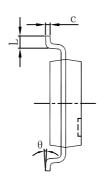


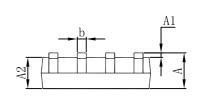
Fig.11 Unclamped Inductive Switching Waveform



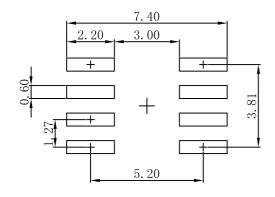
SOP-8(SOIC-8) Package Outline Dimensions







| Symbol | Dimensions In Millimeters | | Dimensions In Inches | | |
|----------|---------------------------|--------|----------------------|--------|--|
| 3y111001 | Min | Max | Min | Max | |
| A | 1.350 | 1.750 | 0.053 | 0.069 | |
| A1 | 0.100 | 0. 250 | 0.004 | 0.010 | |
| A2 | 1.350 | 1.550 | 0.053 | 0.061 | |
| b | 0.330 | 0.510 | 0.013 | 0.020 | |
| c | 0.170 | 0.250 | 0.007 | 0.010 | |
| D | 4.800 | 5.000 | 0.189 | 0. 197 | |
| e | 1. 270 (BSC) | | 0.050 (BSC) | | |
| E | 5.800 | 6. 200 | 0.228 | 0.244 | |
| E1 | 3.800 | 4.000 | 0.150 | 0.157 | |
| L | 0.400 | 1.270 | 0.016 | 0.050 | |
| θ | 0° | 8° | 0° | 8° | |



- Note: 1.Controlling dimension: in millimeters.
- 2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.

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